

Dotted box > PCB manufacturer info

Layer Name	Type	Material	Thickness (mm)	Color	Epsilon R	Loss Tangent
F.Silkscreen	Top Silk Screen	Not specified	0 mm	Not specified	1	0
F.Paste	Top Solder Paste		0 mm		1	0
F.Mask	Top Solder Mask	Not specified	0.01 mm	Not specified	3.3	0
F.Cu	copper		0.035 mm		1	0
Dielectric	core	FR4	1.51 mm	Not specified	4.5	0.02
B.Cu	copper		0.035 mm		1	0
B.Mask	Bottom Solder Mask	Not specified	0.01 mm	Not specified	3.3	0
B.Paste	Bottom Solder Paste		0 mm		1	0
B.Silkscreen	Bottom Silk Screen	Not specified	0 mm	Not specified	1	0

BOARD CHARACTERISTICS

Copper Layer Count: 2

Board Thickness: 1.6000 mm

Board overall dimensions: 19.0500 mm x 50.7951 mm

Min track/spacing: 0.0000 mm / 0.2540 mm

Min hole diameter: 0.3000 mm

Copper Finish: HASL

Impedance Control: No

Castellated pads: No

Plated Board Edge: No

Edge card connectors: No

Outer Copper Weight: 1 oz

Via type: Tented

